

# **DATA SHEET**

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

General purpose & High capacitance Class 2, X5R

100~pF to  $220~\mu F$  RoHS compliant & Halogen free



YAGEO Phicomp



#### SCOPE

This specification describes X5R series chip capacitors with leadfree terminations.

#### <u>APPLICATIONS</u>

PCs, Hard disk, Game PCs Power supplies **DVD** players Mobile phones Data processing

#### **FEATURES**

Supplied in tape on reel Nickel-barrier end termination RoHS compliant Halogen free compliant

#### ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP CTC & 12NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

#### YAGEO BRAND ordering code

#### **GLOBAL PART NUMBER (PREFERRED)**

CC xxxx x x X5R x BB xxx (1) (2) (3) (4)

#### (I) SIZE – INCH BASED (METRIC)

0201 (0603) 0402 (1005)

0603 (1608)

0805 (2012)

1206 (3216)

1210 (3225)

#### (2) TOLERANCE

 $K = \pm 10\%$ 

 $M = \pm 20\%$ 

#### (3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

C = Bulk case

#### (4) RATED VOLTAGE

4 = 4 V

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

9 = 50 V

#### (5) CAPACITANCE VALUE

2 significant digits+number of zeros

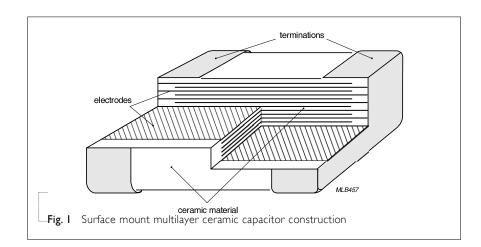
The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $103 = 10 \times 10^3 = 10,000 \text{ pF} = 10 \text{ nF}$ 

#### CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig. I.

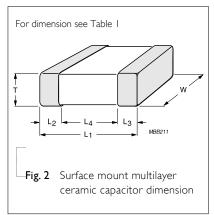


#### **DIMENSION**

**Table I** For outlines see fig. 2

TYPE	L <sub>I</sub> (mm)	W (mm)	T (MM)	L <sub>2</sub> / L <sub>3</sub>	3 (mm)	L <sub>4</sub> (mm)	DIMENSION CODE
				min.	max.	min.	CODE
	0.6 ±0.03	0.3 ±0.03	0.3 ±0.03	0.1	0.2	0.2	ВА
0201	0.6 ±0.05	$0.3 \pm 0.05$	$0.3 \pm 0.05$	0.1	0.2	0.2	BB
0201	0.6 ±0.09	0.3 ±0.09	0.3 ±0.09	0.1	0.25	0.2	BC
	0.6 ±0.15	0.3 ±0.15	0.3 ±0.15	0.1	0.25	0.2	BD
	1.0 ±0.05	0.5 ±0.05	$0.5 \pm 0.05$	0.15	0.35	0.4	CA
0402	1.0 ±0.10	0.5 ±0.10	$0.5 \pm 0.10$	0.15	0.35	0.4	СВ
0402	1.0 ±0.15	0.5 ±0.15	$0.5 \pm 0.15$	0.15	0.35	0.4	CC
	1.0 ±0.20	0.5 ±0.20	0.5 ±0.20	0.15	0.35	0.4	CD
	1.6 ±0.10	0.8 ±0.10	$0.8 \pm 0.10$	0.2	0.6	0.4	DA
0603	1.6 ±0.15	0.8 ±0.15	$0.8 \pm 0.15$	0.2	0.6	0.4	DB
	1.6 ±0.20	0.8 ±0.20	0.8 ±0.20	0.2	0.6	0.4	DC
0805	$2.0 \pm 0.20$	1.25 ±0.20	$0.85 \pm 0.10$	0.25	0.75	0.7	EA
	2.0 ±0.20	1.25 ±0.20	1.25 ±0.20	0.25	0.75	0.7	EB
	3.2 ±0.15	1.6 ±0.15	1.15 ±0.10	0.25	0.75	1.4	FA
1206	$3.2 \pm 0.30$	1.6 ±0.20	1.25 ±0.20	0.25	0.75	1.4	FB
1200	$3.2 \pm 0.30$	1.6 ±0.30	1.60 ±0.20	0.25	0.80	1.4	FC
-	3.2 ±0.30	1.6 ±0.30	1.60 ±0.30	0.30	0.90	1.4	FD
	$3.2 \pm 0.40$	2.5 ±0.30	1.25 ±0.20	0.25	0.75	1.4	GA
1210	$3.2 \pm 0.40$	2.5 ±0.30	1.90 ±0.20	0.25	0.75	1.4	GB
1210	$3.2 \pm 0.40$	2.5 ±0.30	$2.5 \pm 0.20$	0.25	0.75	1.0	GC
-	3.2 ±0.40	2.5 ±0.30	2.5 ±0.30	0.25	0.75	1.0	GD

#### **OUTLINES**





#### CAPACITANCE RANGE & THICKNESS FOR X5R

Table 2 Sizes from 0201 to 0402

CAP.	0201						0402					
	4 V	6.3 V	10 V	16 V	25 V	50 V	4 V	6.3 V	10 V	16 V	25 V	50 V
100 pF		ВА	ВА	ВА	ВА	ВА						
150 pF		ВА	ВА	ВА	ВА	ВА						
220 pF		ВА	ВА	ВА	ВА	ВА						
330 pF		ВА	ВА	ВА	ВА	ВА						
470 pF		ВА	ВА	ВА	ВА	ВА						
680 pF		ВА	ВА	ВА	ВА	ВА						
I.O nF		ВА	ВА	ВА	ВА	ВА						
I.5 nF		ВА	ВА	ВА	ВА							
2.2 nF		ВА	ВА	ВА	ВА							
3.3 nF		ВА	ВА	BA	BA							
4.7 nF		ВА	ВА	ВА	ВА							
6.8 nF		ВА	ВА	ВА	BA							
10 nF		ВА	ВА	ВА	ВА							
15 nF		ВА	ВА	ВА								
22 nF		ВА	ВА	ВА	ВА			CA	CA	CA	CA	CA
33 nF		ВА	ВА	ВА				CA	CA	CA	CA	CA
47 nF		ВА	ВА	ВА				CA	CA	CA	CA	CA
68 nF		ВА	ВА	ВА				CA	CA	CA	CA	CA
100 nF		ВА	ВА	ВА	ВВ			CA	CA	CA	CA	CA
150 nF								CA	CA	CA	CA	CA
220 nF	ВА	ВА	ВА	ВА				CA	CA	CA	CA	CA
330 nF								CA	CA			
470 nF	ВА	ВА	ВА	ВА				CA	CA	СВ	СВ	СВ
680 nF								CA	CA			
Ι.Ο μF	BB	BB	ВВ					CA	CA	CA	CA	
2.2 µF	ВС	ВС	ВС					CA	CA	CC	CD	
4.7 µF	BD						CC	CC	CC	CC		
ΙΟ μΕ							CD	CD	CD			
22 µF							CD	CD				

#### NOTE

- I. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is available on request

#### CAPACITANCE RANGE & THICKNESS FOR X5R

Table 3	Sizes	from	0603	to	0805
Table 3	Sizes	trom	0603	to	0805

CAP.	0603						0805					
	4V	6.3 V	10 V	16 V	25 V	50V	4V	6.3 V	10 V	16 V	25 V	50V
10 nF												
15 nF												
22 nF												
33 nF												
47nF												
68 nF												
100 nF												
150 nF												
220 nF		DA	DA	DA	DA	DA						
330 nF		DA	DA	DA	DA	DA						
470 nF		DA	DA	DA	DA	DA		EA EB	EA EB	EA EB	EB	EB
680 nF		DA	DA	DA	DA	DA		EA EB	EA EB	EA EB	EB	EB
Ι.Ο μF		DA	DA	DA	DA	DA		EA EB	EA EB	EA EB	EB	EB
2.2 µF		DA	DA	DA	DB	DC		EA EB	EA EB	EA EB	EA EB	EB
4.7 µF		DA	DA	DB	DB			EA EB	EA EB	EB	EB	EB
10 μF		DB	DC	DC	DC			EA EB	EA EB	EB	EB	EB
22 µF		DC	DC					EB	EB	EB	EB	
47 µF	DC	DC						EB	EB			
Ι00 μF							EB	EB				

#### NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is available on request

18

1			1206 to 121	0								
C	CAP.	1206 4 V	6.3 V	10 V	16 V	25 V	50V	1210 6.3 V	10 V	16 V	25 V	50V
	10 nF											
	15 nF											
	22 nF											
	33 nF											
	47nF											
	68 nF											
	100 nF											
	150 nF											
	220 nF											
	330 nF											
	470 nF											
	680 nF											
	Ι.0 μF		FA	FA	FA	FA	FC	GA	GA	GA	GA	GA
	2.2 µF		FA	FA	FA	FA	FC	GB	GB	GB	GB	GB
	4.7 µF		FC	FC	FC	FC	FC	GB	GB	GB	GB	GC
	ΙΟ μΕ		FC	FC	FC	FC	FD	GB	GB	GB	GB	GC
	22 µF		FC	FC	FC	FD		GC	GC	GC	GD	
	47 μF		FC	FC	FD			GC	GC	GC		
	Ι00 μF		FD					GD	GD	GD		
	220 µF	FD						GD				

#### NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is available on request

#### THICKNESS CLASSES AND PACKING QUANTITY

_	_			_
	la	h	А	١,

SIZE	THICKNESS	TAPE WIDTH -	Ø180 MM	/7 INCH	Ø330 MM	/ 13 INCH	QUANTITY
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister	PER BULK CASE
0201	0.3 ±0.03 mm	8 mm	15,000		50,000		
0402	0.5 ±0.05 / 0.1 mm	8 mm	10,000		50,000		50,000
0402	0.5 ±0.15 / 0.2 mm	8 mm	10,000		40,000		
0603	0.8 ±0.1 mm	8 mm	4,000		15,000		15,000
	0.6 ±0.1 mm	8 mm	4,000		20,000		10,000
0805	0.85 ±0.1 mm	8 mm	4,000		15,000		8,000
	1.25 ±0.2 mm	8 mm		3,000		10,000	5,000
	0.6 ±0.1 mm	8 mm	4,000		20,000		
	0.85 ±0.1 mm	8 mm	4,000		15,000		
1206	1.00 / 1.15 ±0.1 mm	8 mm		3,000		10,000	
1200	1.25 ±0.2 mm	8 mm		3,000		10,000	
	1.6 ±0.15 mm	8 mm		2,500		10,000	
	1.6 ±0.2 mm	8 mm		2,000		8,000	
	$0.6 / 0.7 \pm 0.1 \text{ mm}$	8 mm		4,000		15,000	
	0.85 ±0.1 mm	8 mm		4,000		10,000	
	1.15 ±0.1 mm	8 mm		3,000		10,000	
	1.15 ±0.15 mm	8 mm		3,000		10,000	
	1.25 ±0.2 mm	8 mm		3,000			
1210	1.5 ±0.1 mm	8 mm		2,000			
-	1.6 / 1.9 ±0.2 mm	8 mm		2,000			
	2.0 ±0.2 mm	8 mm		2,000 1,000			
	2.5 ±0.2 mm	8 mm		1,000 500			

#### **ELECTRICAL CHARACTERISTICS**

#### **X5R DIELECTRIC CAPACITORS; NISN TERMINATIONS**

Unless otherwise specified, all tests and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Table 6

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

DESCRIPT Capacitanc						100 5	VALUE
	e tolerance						to 220 μF
	factor (D.F.)					±10%	and ±20%
X5R	0201	0402	0603	0805	1206	1210	D.F.
≤ 6.3V	100pF to 10nF	22nF to 100nF	220nF to TuF	470nF to 680nF	luF to 10uF	luF to 10uF	≤ 5%
		120nF to 220nF				22uF	≤ 7%
	12nF to 1uF	330nF to 10uF	2.2uF to 47uF	luF to 100uF	22uF to 47uF	47uF to 220uF	≤ 10%
	2.2uF				100uF, 220uF		≤ 15%
	4.7uF	22uF					≤ 20%
10V	100pF to 10nF	22nF to 100nF	220nF to 470nF	470nF to 680nF	IuF to 4.7uF	IuF to 4.7uF	≤ 5%
		120nF to 220nF	680nF	IuF			≤ 7%
	12nF to 220nF, 1uF	330nF to 10uF	IuF to 22uF	2.2uF to 47uF	10uF to 47uF	10uF to 100uF	≤ 10%
	470nF						≤ 15%
	2.2uF						≤ 20%
16V	100pF to 10nF	22nF to 100nF	220nF to 470nF	470nF to 680nF	luF to 4.7uF	luF to 4.7uF	≤ 5%
		120nF to 220nF	680nF to TuF	I uF to 2.2 <b>µ</b> F			≤ 7%
	12nF to 220nF	470nF to 4.7uF	2.2uF to 10uF	4.7uF to 22uF	10uF to 47uF	10uF to 100uF	≤ 10%
	470nF						≤ 20%
25V	100pF to 10nF	22nF		470nF to TuF	luF to 2.2uF	luF to 4.7uF	≤ 3.5%
		27nF to 100nF	220nF to 470nF	2.2uF	4.7uF	I OuF	≤ 5%
		I 20nF to 220nF	680nF to TuF				≤ 7%
	22nF, 100nF	470nF to 2.2uF	2.2uF to 10uF	4.7uF to 22uF	10uF to 22uF	22uF	≤ 10%
50V	100pF to 1nF	22nF					≤ 3.5%
		27nF to 120nF					≤ 5%
		150nF to 220nF					≤ 7%
		470nF	220nF to 2.2uF	470nF to 10uF	IuF to IOuF	luF to 10uF	≤ 10%
Insulation	resistance after I min	ute at Ur (DC)	R	ins≥ 10 GΩ or Ri	ns × Cr≥ 50/100/5	500* seconds which	ever is less
	capacitance change as a	•	erature				±15%
<u> </u>	re characteristic/coefficetemperature range:	cient):					to +85 °C

#### NOTE

\* Rins  $\geq$  10 G $\Omega$  or Rins  $\times$  Cr  $\geq$  500 $\Omega$ .F:

0201: 100pF to 47nF 0402 : 22nF to 470nF 0603 : 220nF to TuF

0805 : 470nF to 2.2uF, 4.7uF/6.3V to 16V 1206 : IuF to 2.2uF, 4.7uF/6.3V to 16V

1210 : IuF to 2.2uF, 4.7uF/6.3V to 16V

\* Rins × Cr  $\geq$  50 $\Omega$ .F:

0201 : luF 0402 : IOuF 0603 : IOuF to 22uF

0805: 10uF/50V, 47uF to 100uF

1206: 100uF, 220uF

\* Rins ×  $Cr \ge 100\Omega$ .F:

0201: 100nF to 470nF 0402 : I uF to 4.7uF 0603: 2.2uF to 4.7uF

0805:4.7 uF/16V to 50V, 10uF to 22uF/4V to 25V

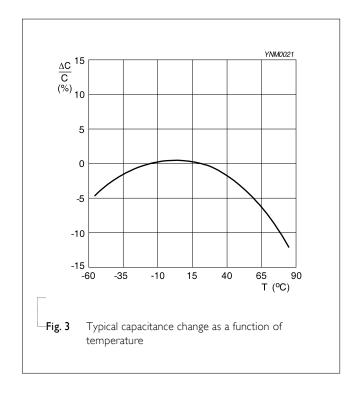
1206: 4.7uF/25V to 50V, 10uF to 47uF

1210: 47uF to 220uF

\* Rins × Cr  $\geq$  20 $\Omega$ ,F:

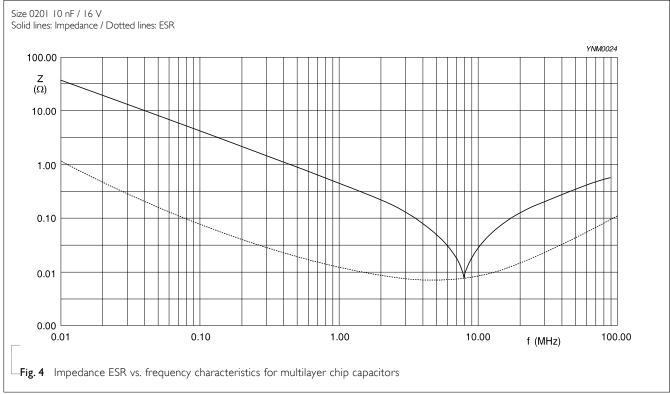
0201: 2.2uF to 4.7uF

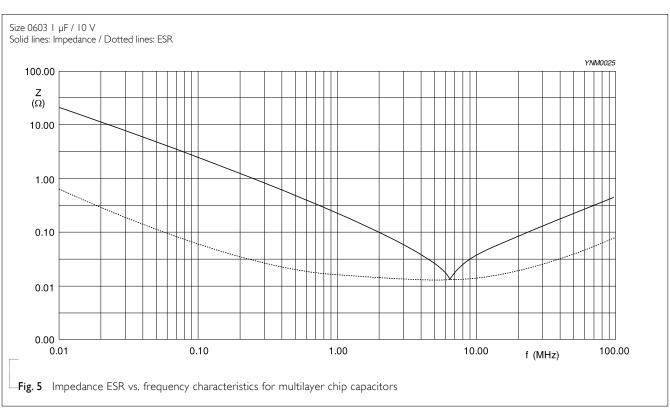
0402 : 22uF 0603 : 47uF

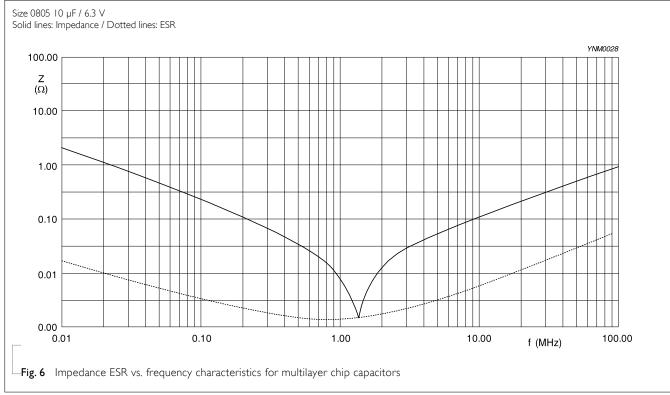


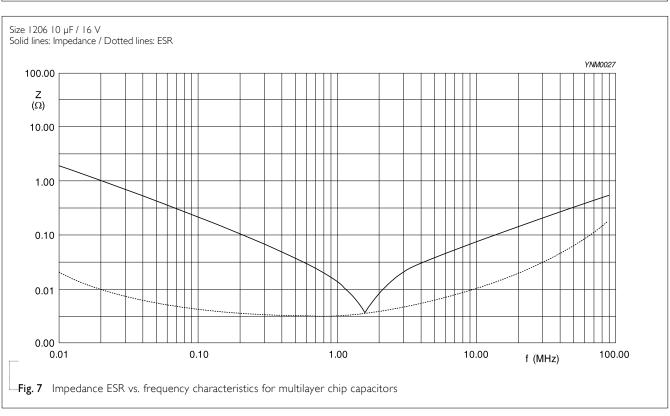


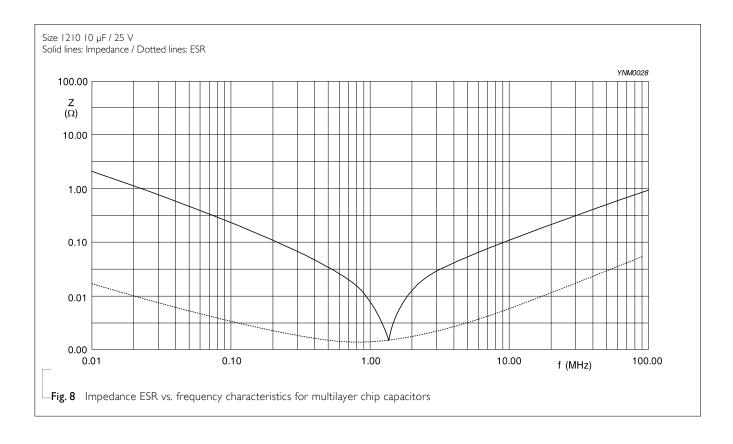












#### **SOLDERING RECOMMENDATION**

Table 7						
SOLDERING	SIZE					
METHOD	0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	> 100 nF	> IµF	> 2.2 µF	> 2.2 µF	Reflow only

≤ IµF

≤ 2.2 µF

≤ 2.2 µF

≤ 100 nF

Reflow/Wave

### TESTS AND REQUIREMENTS

**Table 8** Test procedures and requirements

TEST	TEST MET	HOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance (I)		4.5.1	Class 2:	Within specified tolerance
Dissipation Factor (D.F.) <sup>(1)</sup>		4.5.2	At 20 °C, 24 hrs after annealing Cap $\leq$ I $\mu$ F, f = I KHz, measuring at voltage I Vrms at 20 °C Cap > IuF, f = I KHz for C $\leq$ I0 $\mu$ F, rated voltage > 6.3 V, measuring at voltage I Vrms at 20 °C f = I KHz, for C $\leq$ I0 $\mu$ F, rated voltage $\leq$ 6.3 V, measuring at voltage 0.5 Vrms at 20 °C f = I20 Hz for C > I0 $\mu$ F, measuring at voltage 0.5 Vrms at 20 °C	
Insulation Resistance		4.5.3	At $U_r$ (DC) for I minute	In accordance with specification

#### NOTE

 $I.\ The\ figure\ indicates\ typical\ inspection.\ Please\ refer\ to\ individual\ specifications.$ 

**REQUIREMENTS** <General purpose series>

 $\Delta$  C/C:  $\pm 30$ ppm

X7R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82%

<High Capacitance series>

 $\times$ 7R/ $\times$ 5R:  $\Delta$  C/C:  $\pm$ 15% Y5V: Δ C/C: 22~-82%

Class I:

Class2:

Class2:

#### TEST **TEST METHOD PROCEDURE**

#### Temperature Characteristic

4.6 Capacitance shall be measured by the steps shown in the following table.

> The capacitance change should be measured after 5 min at each specified temperature stage.

Step	Temperature(°C)
a	25±2
Ь	Lower temperature±3℃
С	25±2
d	Upper Temperature±2℃
е	25±2

(I) Class I

Temperature Coefficient shall be calculated from the formula as below

Temp, Coefficient = 
$$\frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$$

C1: Capacitance at step c

C2: Capacitance at 125°C

 $\Delta T$ : 100°C(=125°C-25°C)

#### (2) Class II

Capacitance Change shall be calculated from the formula

$$\Delta C = \frac{C2 - C1}{C1} \times 100\%$$

C1: Capacitance at step c

C2: Capacitance at step b or d

#### Adhesion

4.7 A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate

Force

size ≥ 0603: 5N size = 0402: 2.5N size = 0201: 1N

#### Bending Strength

IEC 60384-21/22

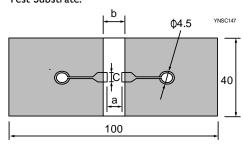
4.8

Mounting in accordance with IEC 60384-22 paragraph 4.3

No visible damage

Conditions: bending I mm at a rate of I mm/s, radius jig 5 mm

#### Test Substrate:



Unit: mm

## $\Delta$ C/C

Class2:

<General purpose series>

X5R: ±10%

<High Capacitance series>

X5R: ±12.5%

	Dimension(mm)						
Туре	a b c						
0201	0.3	0.9	0.3				
0402	0.4	1.5	0.5				
0603	1.0	3.0	1.2				
0805	1.2	4.0	1.65				
1206	2.2	5.0	1.65				
1210	2.2	5.0	2.0				

Surface Mount Multilayer Ceramic Capacitors | General Purpose & High Cap. | X5R | 4 V to 50 V

TEST	TEST METH	OD	PROCEDURE	REQUIREMENTS
Resistance to Soldering Heat	4.9		Precondition: $150 \pm 0/-10$ °C for I hour, then keep for 24 ± I hours at room temperature  Preheating: for size $\leq 1206$ : $120$ °C to $150$ °C for I	Dissolution of the end face plating shal not exceed 25% of the length of the edge concerned
			minute	<general purpose="" series=""></general>
			Preheating: for size $>$ 1206: 100 °C to 120 °C for I	ΔC/C
			minute and 170 °C to 200 °C for I minute	Class2:
			Solder bath temperature: 260 ±5 °C	X5R: ±10%
			Dipping time: $10 \pm 0.5$ seconds	<high capacitance="" series=""></high>
			Recovery time: 24 ±2 hours	ΔC/C
				Class2:
				X5R: ±10%
			-	D.F. within initial specified value R <sub>ins</sub> within initial specified value
Solderability		4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
			I. Temperature: 235±5°C / Dipping time: 2 ±0.5 s	
			2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)	
			Depth of immersion: 10mm	
Rapid Change of	IEC 60384- 21/22	4.11	Preconditioning; 150 +0/-10 °C for I hour, then keep for 24 ±1 hours at _	No visual damage
Temperature			room temperature	<general purpose="" series=""></general>
				ΔC/C
			5 cycles with following detail:	Class2:
			30 minutes at lower category temperature 30 minutes at upper category temperature	X5R: ±15%
				<high capacitance="" series=""></high>
			Recovery time 24 ±2 hours	ΔC/C
				Class2:
				X5R: ±15%
			-	D.F. meet initial specified value
				R <sub>ins</sub> meet initial specified value

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Damp Heat with U <sub>r</sub> Load	4.13	1. Preconditioning, class 2 only:	No visual damage after recovery
with O <sub>r</sub> Load		<ul> <li>150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp</li> <li>2. Initial measure:     Spec: refer to initial spec C, D, IR</li> <li>3. Damp heat test:     500 ±12 hours at 40 ±2 °C;     90 to 95% R.H. 1.0 U<sub>r</sub> applied</li> </ul>	<general purpose="" series=""></general>
			ΔC/C
			Class2:
			X5R: ±15%
			D.F.
			Class2:
		<ul><li>4. Recovery:     Class 2: 24 ±2 hours</li><li>5. Final measure: C, D, IR</li></ul>	X5R:
			$\leq$ 16V: $\leq$ 7% or 2 x initial value whichever is greater
			$\geq$ 25V: $\leq$ 5% or 2 × initial value whichever
			is greater
		P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirements shall be met.	R <sub>ins</sub>
			Class2:
			$X5R$ : ≥ 500 M $\Omega$ or $R_{ins} \times C_r \ge 25s$
			whichever is less
		* General product:	<high capacitance="" series=""></high>
		0201 < 100nF	$\Delta$ C/C
		0402 < TuF	Class2:
		0603 < 2.2uF 0805, 1206, 1210 < 4.7uF	X5R: ±20%
			D.F.
		* High cap product:	Class2:
		** Figh cap product: 0201 ≥ 100nF 0402 ≥ 1uF 0603 ≥ 2.2uF 0805, 1206, 1210 ≥ 4.7uF	X5R: 2 × initial value max
			R <sub>ins</sub>
			Class2:
			Rins x Cr ≥ 5s
			whichever is less

## Surface Mount Multilayer Ceramic Capacitors General Purpose & High Cap. X5R 4 V to 50 V

TEST Endurance	TEST METHOD		PROCEDURE	REQUIREMENTS	
	IEC 60384- 21/22	4.14	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 $\pm$ 1 hour at $_{-}$	No visual damage	
			room temp	<general purpose="" series=""></general>	
			2. Initial measure:	ΔC/C	
			Spec: refer to initial spec C, D, IR	Class2:	
			3. Endurance test:	X5R: ±15%	
			Temperature: X5R: 85 °C	D.F.	
			Specified stress voltage applied for 1,000 hours: Applied 2.0 × Ur for general product*.	Class2: X5R:	
			Applied 1.5 × Ur for high cap. product*.		
			Applied I.0 × Ur for high cap. product*.	$\leq$ 16V: $\leq$ 7% or 2 × initial value whichever is greater	
			4. Recovery time: 24 ±2 hours	≥ 25V: ≤ 5% or 2 × initial value whichever	
			5. Final measure: C, D, IR	is greater	
			P.S. If the capacitance value is less than the minimum	R <sub>ins</sub>	
			value permitted, then after the other measurements	Class2:	
			have been made the capacitor shall be preconditioned	$X5R: \ge 1,000 \text{ M}\Omega \text{ or } R_{ins} \times C_r \ge 50s$	
			according to "IEC 60384 4.1" and then the requirements	whichever is less	
			shall be met.	<high capacitance="" series=""></high>	
			* General product (Applied 2.0 × Ur):	ΔC/C	
			0201 < 100nF	Class 2:	
			0402 < IuF	X5R: ±20%	
			0603 < 2.2uF	D.F.	
			0805, I206, I2I0 < 4.7uF	Class 2:	
				X5R: 2 × initial value max	
			* High cap product (Applied 1.5 $\times$ Ur):	R <sub>ins</sub>	
			0201 ≥ 100nF	Class 2:	
			0402 ≥ IuF	Rins x Cr ≥ 10s	
			0603 ≥ 2.2uF 0805, 1206, 1210 ≥ 4.7uF	whichever is less	
			* High cap product (Applied 1.0 × Ur): 0201: 100nF/25V, 2.2uF to 4.7uF		
			0402: 4.7uF to 22uF		
			0603: 10uF/10V to 25V 22uF to 47uF		
			0805: 10uF/ 25V, 50V, 22uF to 100uF 1206: 10uF/ 50V		
Voltage Proof		4.6	Specified stress voltage applied for 1~5 seconds	No breakdown or flashover	
Proof			$Ur \le 100 \text{ V}$ : series applied 2.5 $Ur$		
			100 V < Ur ≤ 200 V series applied		
			(1.5  Ur + 100)		
			200 V < Ur ≤ 500 V series applied		
			(1.3  Ur + 100)		
			Ur > 500 V: 1.3 Ur		
			Ur ≥ 1000 V: 1.2 Ur  Charge/Discharge gureent is less than 50 m A		
			Charge/Discharge current is less than 50 mA		

#### REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 25	Jun. 2, 2017	-	- I.R spec updated
Version 24	Mar. 6, 2017	-	- 0805 L4 spec updated
Version 23	Nov. 15, 2016	-	- Dimension updated
Version 22	Oct. 3, 2016	-	- Dimension and Soldering recommendation updated
Version 21	Jan. 28, 2016	-	- Tests and requirements updated
Version 20	Dec. 04, 2015	-	- Size updated
Version 19	Apr. 09, 2015	-	- Voltage updated
Version 18	Jul. 07, 2014	-	- Voltage updated
Version 17	Mar. 31, 2014	-	- Test condition updated
Version 16	Nov. 29, 2012	-	- Test condition updated
Version 15	Sep. 03, 2012	-	- Test condition updated
Version 14	May 16, 2012	-	- Product range updated
Version 13	May 02, 2012	-	- Product range updated
Version 12	Feb 10, 2012	-	- Product range updated
Version 11	Oct 21, 2011	-	- Product range updated
Version 10	Jun 21, 2011	-	- Product range updated
Version 9	Mar 23, 2011	-	- Product range updated
Version 8	Jan 25, 2011	-	- Rated voltage of 0201 extend to 50V
Version 7	Jan 05, 2011	-	- Product range updated
Version 6	Jul 27, 2010	-	- Dimension on 0603 and 1206 case size updated
Version 5	Apr 21, 2010	-	- The statement of "Halogen free" on the cover added
			- Dimension updated
Version 4	Jan 13, 2010	-	- Thickness updated
Version 3	Aug 17, 2009	-	- Dimension updated
Version 2	Jun 09, 2009	-	- Ordering code updated
Version I	May 15, 2009	-	- Product range updated
Version 0	Apr 15, 2009	-	<ul> <li>New datasheet for general purpose and high capacitance X5R series with RoHS compliant</li> <li>Replace the "6.3V to 50V" part of pdf files: UP-X5R_X7R_HighCaps_6.3-to-25V_II, UY-X5R_X7R_HighCaps_6.3-to-25V_II</li> </ul>
			<ul> <li>Combine 0201 from pdf files: UP-NP0X5RX7RY5V_0201_6.3-to-50V_2 and UY-NPOX5RX7RY5V_0201_6.3-to-50V_2</li> <li>Define global part number</li> <li>Description of "Halogen free compliant" added</li> <li>Test method and procedure updated</li> </ul>

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Multilayer Ceramic Capacitors MLCC - SMD/SMT category:

Click to view products by Yageo manufacturer:

Other Similar products are found below:

M39014/02-1225V M39014/22-0631 D55342E07B523DR-T/R NCA1206X7R103K50TRPF NCA1206X7R104K16TRPF NIN-FB391JTRF

NIN-FC2R7JTRF NMC0201X5R474K4TRPF NMC0402NPO220J50TRPF NMC0402X5R105K6.3TRPF NMC0402X5R224K6.3TRPF

NMC0402X7R103J25TRPF NMC0402X7R153K16TRPF NMC0603NPO1R8C50TRPF NMC0603NPO201J50TRPF

NMC0603NPO330G50TRPF NMC0603X5R475M6.3TRPF NMC0805NPO270J50TRPF NMC0805NPO820J50TRPF

NMC0805X7R224K25TRPF NMC1206X7R102K50TRPF NMC-H0805X7R472K250TRPF NMC-L0402NPO7R0C50TRPF NMC-L0603NPO2R2B50TRPF NMC-P0805NPO221J500TRPLPF NMC-Q0402NPO8R2D200TRPF C1206C101J1GAC C1608C0G2A221J

C1608X7R1E334K C2012C0G2A472J 2220J2K00562KXT 1812J2K00332KXT CDR31BX103AKWR CDR33BX104AKUR

CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D

CGA2B2C0G1H120J CGA2B2C0G1H391J CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D